

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT6277635

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
XIAO FENG WANG	05/01/2020
JUN MA	04/30/2020
QIANG WU	07/31/2020
HUILIN XU	05/08/2020
IYAB ISSAM SAKHNINI	04/30/2020
DAN ZHANG	05/15/2020
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	QUALCOMM INCORPORATED
<b>Street Address:</b>	5775 MOREHOUSE DRIVE
<b>City:</b>	SAN DIEGO
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	92121-1714
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16805472
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(949)202-3001
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	949-202-3031
<b>Email:</b>	trang.nguyen@haynesboone.com, ipdocketing@haynesboone.com
<b>Correspondent Name:</b>	HAYNES AND BOONE, LLP
<b>Address Line 1:</b>	2323 VICTORY AVENUE, SUITE 700
<b>Address Line 4:</b>	DALLAS, TEXAS 75219
<b>ATTORNEY DOCKET NUMBER:</b>	49606.730US01 (201227)
<b>NAME OF SUBMITTER:</b>	JONATHAN W. HALLMAN
<b>SIGNATURE:</b>	/Jonathan W. Hallman/
<b>DATE SIGNED:</b>	09/01/2020
<b>Total Attachments: 18</b>	

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source=49606.730US01 Assignment#page18.tif

**ASSIGNMENT**

WHEREAS, WE,

1. **Xiao Feng WANG**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121**,
2. **Jun MA**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121**,
3. **Qiang WU**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121**,
4. **Huilin XU**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121**,
5. **Iyab Issam SAKHNINI**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121**,
6. **Dan ZHANG**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121**,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **UPLINK FREQUENCY AND TIMING COMPENSATION IN A NON-TERRESTRIAL NETWORK** (collectively the "INVENTION") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below,

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). **16/805,472** filed **February 28, 2020**, Qualcomm Reference Number **201227**, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional

applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;


PATENT

Qualcomm Reference Number 201227

Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at San Diego, CA, on 05/01/2020  
City, State Date

  
Xiao Feng WANG

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date

Jun MA

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date

Qiang WU

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date

Huilin XU

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date

Iyab Issam SAKHNINI

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date

Dan ZHANG

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AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date

\_\_\_\_\_  
Xiao Feng WANG

Done at San Diego, CA, on 04/30/20  
City, State Date

\_\_\_\_\_  
Jun MA

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date

\_\_\_\_\_  
Qiang WU

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date

\_\_\_\_\_  
Huilin XU

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date

\_\_\_\_\_  
Iyab Issam SAKHINI

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date

\_\_\_\_\_  
Dan ZHANG



**ASSIGNMENT**

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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

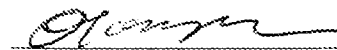
Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date

Xiao Feng WANG

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date

Jun MA

Done at San Diego, CA, on 7/31/2020  
City, State Date

  
Qiang WU

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date

Huilin XU

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date

Iyab Issam SAKHNINI

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date

Dan ZHANG

**ASSIGNMENT**

WHEREAS, WE,

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applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

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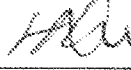
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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date **Xiao Feng WANG**

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date **Jun MA**

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date **Qiang WU**

Done at San Diego, CA, on 05/08/2020   
City, State Date **Huilin XU**

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date **Iyab Issam SAKHNINI**

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date **Dan ZHANG**

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Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date Xiao Feng WANG

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date Jun MA

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date Qiang WU

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date Huilin XU

Done at SANDIEGO, CA, on 30 April 2020  
City, State Date Iyab Issam SAKHINI

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date Dan ZHANG

**ASSIGNMENT**

WHEREAS, WE,

1. **Xiao Feng WANG**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121**,
2. **Jun MA**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121**,
3. **Qiang WU**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121**,
4. **Huilin XU**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121**,
5. **Iyab Issam SAKHNINI**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121**,
6. **Dan ZHANG**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121**.

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **UPLINK FREQUENCY AND TIMING COMPENSATION IN A NON-TERRESTRIAL NETWORK** (collectively the “**INVENTION**”) for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter “**ASSIGNEE**”), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said **INVENTIONS**, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto **ASSIGNEE**, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said **INVENTIONS**, including all patent applications therefor that may have been filed or may be filed hereafter for said **INVENTIONS** in the United States, including but not limited to U.S. Application No(s). **16/805,472** filed **February 28, 2020**, Qualcomm Reference Number **201227**, (and do hereby authorize **ASSIGNEE** and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional

applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date Xiao Feng WANG

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date Jun MA

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date Qiang WU

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date Huilin XU

Done at \_\_\_\_\_, on \_\_\_\_\_  
City, State Date Iyab Issam SAKHINI

Done at San Diego, CA, on 5/15/2020  
City/State Date Zhang Dan  
Dan ZHANG